



Welcome to E-XFL.COM

#### What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

#### Details

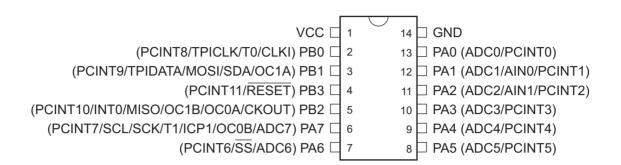
Product Status	Active
Core Processor	AVR
Core Size	8-Bit
Speed	12MHz
Connectivity	I <sup>2</sup> C, SPI
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	12
Program Memory Size	2KB (1K x 16)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	128 x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	14-TSSOP (0.173", 4.40mm Width)
Supplier Device Package	14-TSSOP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/attiny20-xu

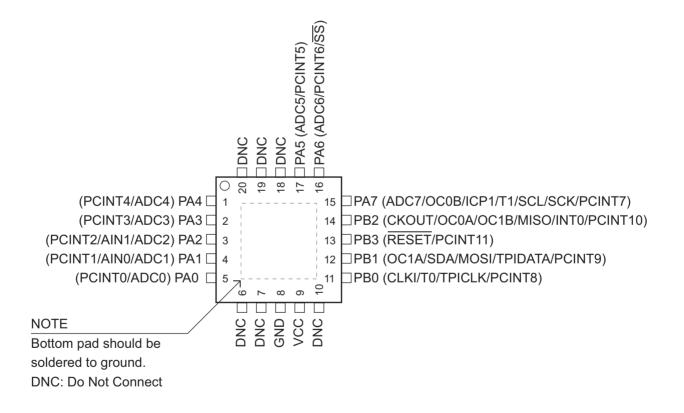
Email: info@E-XFL.COM

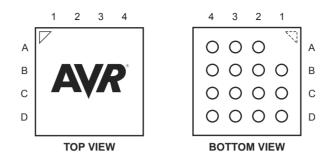
Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

#### Features

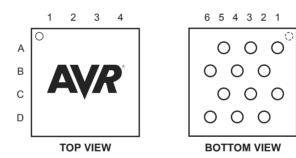
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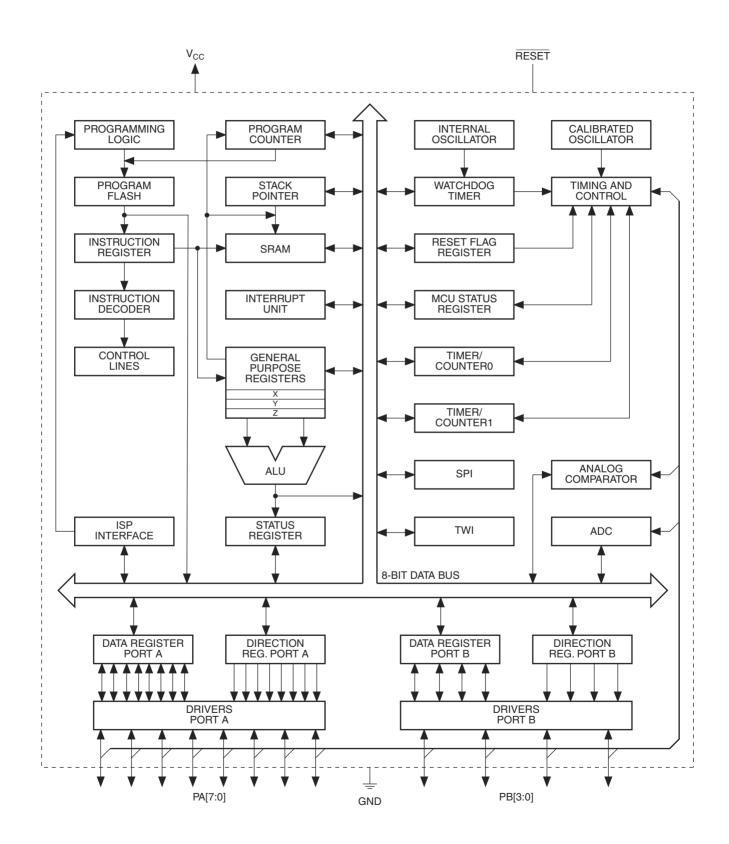
	1	2	3	4	5	6
Α	PA4		PA1		PA2	
В						VDD
С	PA5					
D						PB0

page 170

"Alternate Port Functions" on page 47

page 37

Table 20-4 on



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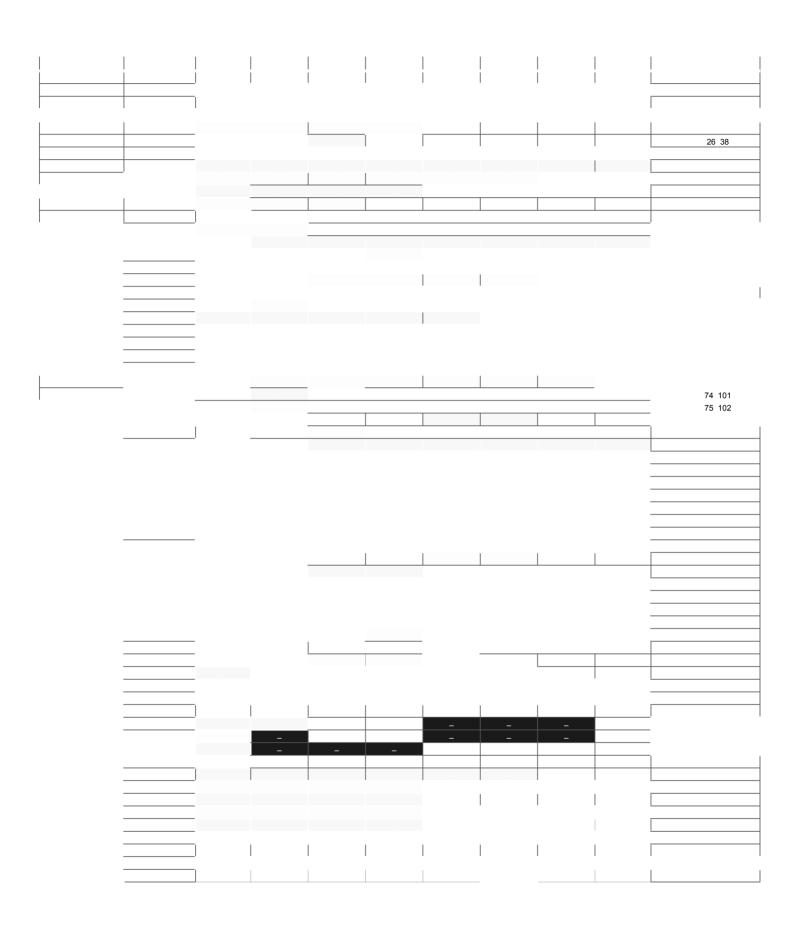


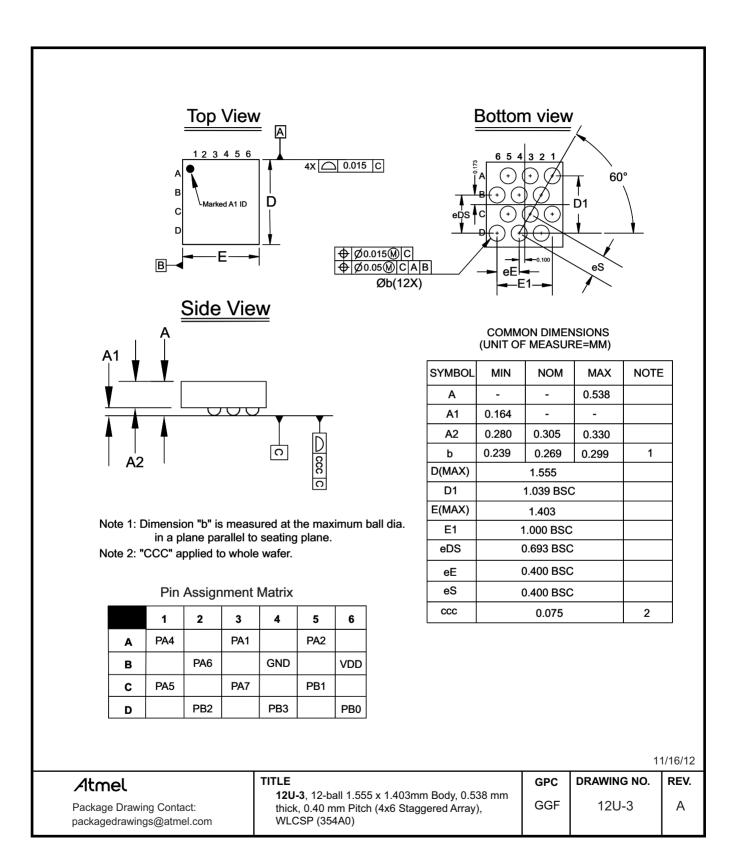
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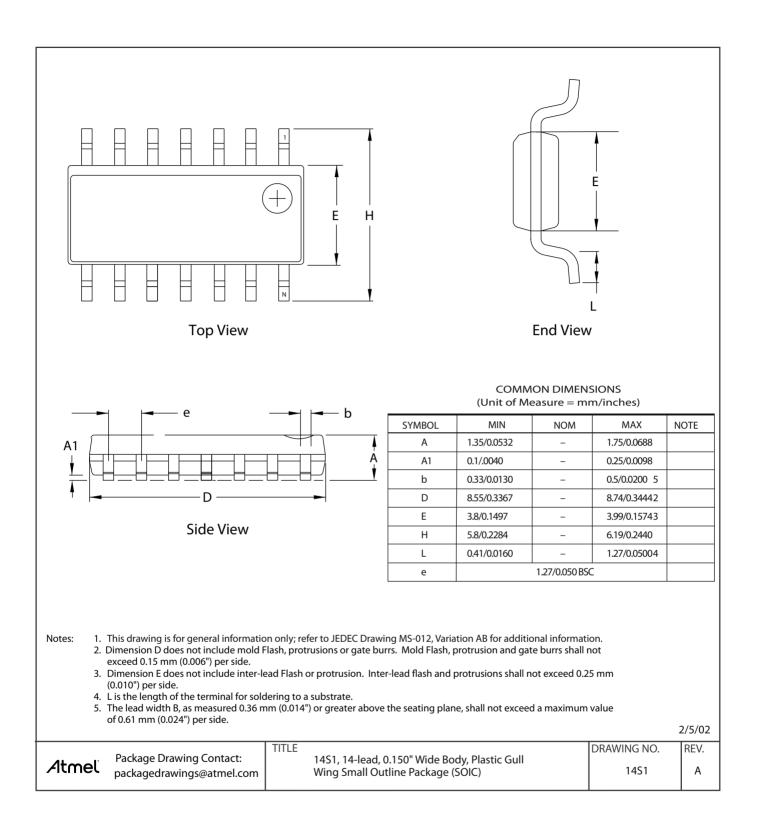
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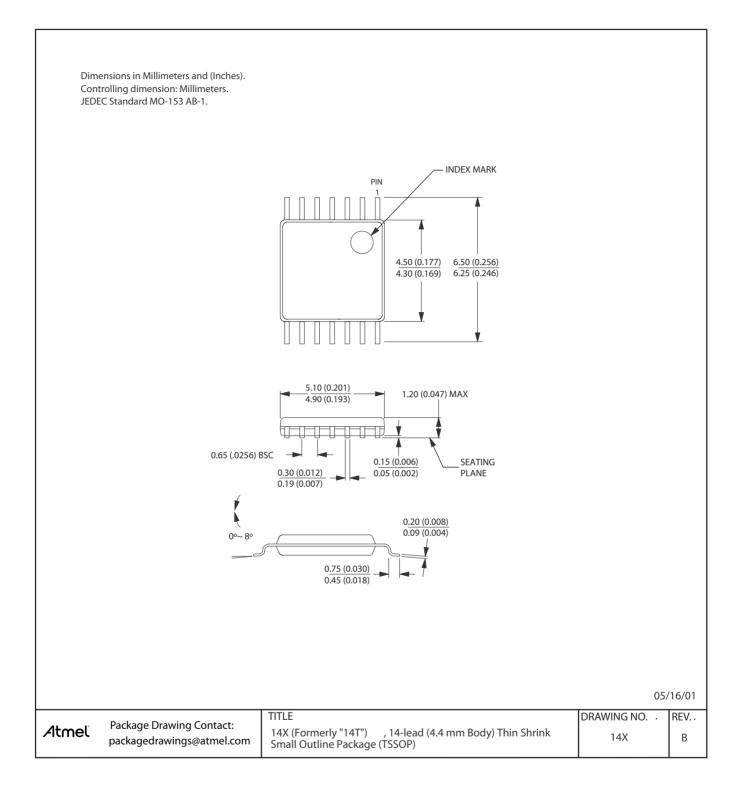
Speed	Supply Voltage	Temperature Range	Package <sup>(2)</sup>	Ordering Code <sup>(1)</sup>
		Industrial (-40°C to +85°C) <b>(4)</b>		ATtiny20-UUR
				ATtiny20-SSU
				ATtiny20-SSUR
				ATtiny20-XU
12 MHz				ATtiny20-XUR
				ATtiny20-CCU
				ATtiny20-CCUR
				ATtiny20-MMH <sup>(3)</sup>
				ATtiny20-MMHR <sup>(3)</sup>

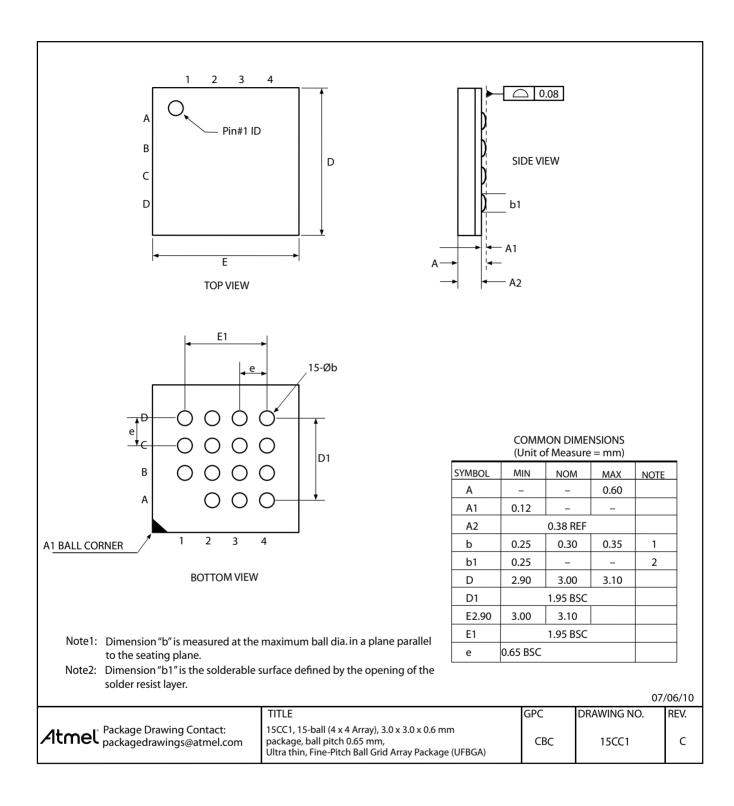
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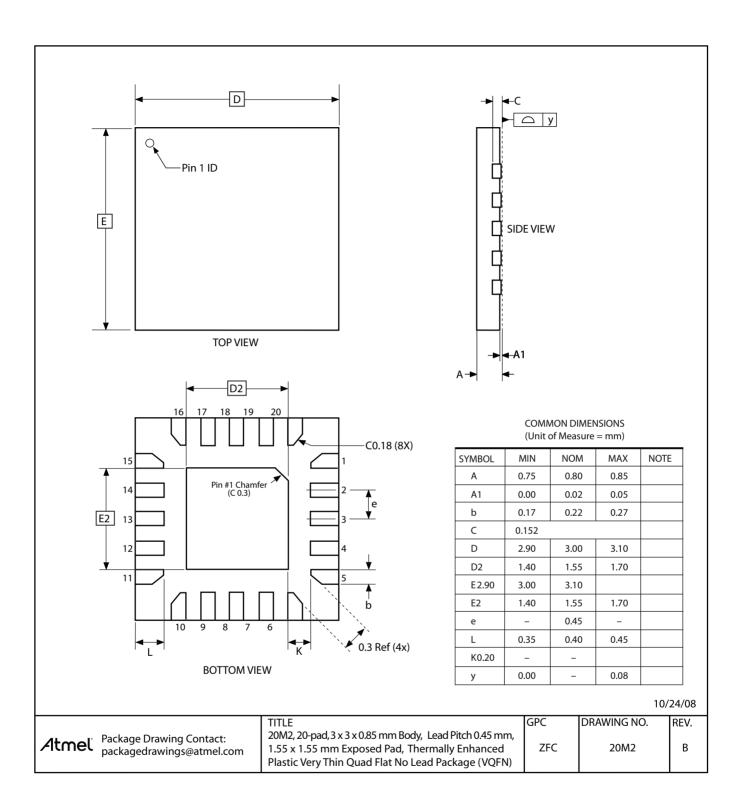
	Package Type
12U-1	12-ball 1.540 x 1.388mm Body, 0.433 mm thick, 0.40 mm Pitch (3x4 Staggered Array), WLCSP
14S1	
14X	14-lead, 4.4 mm Body, Thin Shrink Small Outline Package (TSSOP)
15CC1	
20M2	20-pad, 3 x 3 x 0.85 mm Body, Very Thin Quad Flat No Lead Package (VQFN)











Revision	Date	Comments
8235F	09/2014	Changed text in Section 7.1 from 12U-1 to 12U-3. Updated back page.
8235E	03/13	Updated WLCSP ball configuration on page 3. Updated WLCSP package drawing, "12U-3" on page 13
8235D	10/12	Updated Document template, and "Pin Configurations" on page 2
8235C	06/12	Updated "Ordering Information" on page 12. Added Wafer Level Chip Scale Package "12U-3" on page 13.
8235B		Removed Preliminary Status     page 6 "Capacitive Touch Sensing" on page 7     "Disclaimer" on page 7     "Disclaimer" on page 7     "Analog Input Circuitry" on page 116     page 60     "Watchdog Reset" on page 30     "Encoded Compare Output Mode and Waveform Generation" on page 63     Figure 11-5 on page 64     Figure 11-7 on page 67     page 67     page 67     page 70     Figure 12-1 on page 77     1 on page 76     Table 12-1 on page 174     "Speed" on page 129     Table 15-4 on page 179     Table 15-4 on page 121
		page 175 MISO output driver errata for device rev. A in "Errata" on page 18
8235A		

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